

Electronic Patent Application Fee Transmittal

Application Number:	10517445			
Filing Date:	09-Dec-2004			
Title of Invention:	Circuit formation substrate manufacturing method and circuit formation substrate material			
First Named Inventor/Applicant Name:	Toshihiro Nishii			
Filer:	Walter Carl Pledger/Linda Deutscher			
Attorney Docket Number:	2004-1930A			

Filed as Large Entity

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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

Pages:

Claims:

Miscellaneous-Filing:

Petition:

Patent-Appeals-and-Interference:

Notice of appeal	1401	1	540	540
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Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				540